

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4948907

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TZU-HUNG LIN	03/14/2012
WEN-SUNG HSU	03/14/2012
TAI-YU CHEN	03/14/2012
RECEIVING PARTY DATA	
Name:	MEDIATEK INC.
Street Address:	NO. 1, DUSING RD. 1ST,
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSIN-CHU 300
State/Country:	TAIWAN
Postal Code:	R.O.C.
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15189369
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	M1295.70066US02
NAME OF SUBMITTER:	EVIS KAPO
SIGNATURE:	/Evis Kapo/
DATE SIGNED:	05/07/2018
Total Attachments: 1	
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ASSIGNMENT

WHEREAS, Tzu-Hung LIN, Wen-Sung HSU, and Tai-Yu CHEN
hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements
as described and set forth in the below identified application for United States Letters Patent:
Title: SEMICONDUCTOR PACKAGE

Filed: _____ Serial No. _____
Executed on: March 14, 2012

WHEREAS, MediaTek Inc. of No. 1, Dusing Rd. 1st, Science-
Based Industrial Park, Hsin-Chu 300, Taiwan, R.O.C. hereinafter
referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said
invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for
good and valuable consideration, receipt of which is hereby acknowledged by Assignor,
Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign
and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their
rights, title and interest in and to the said invention and application and all future
improvements thereon, and in and to any Letters Patent which may hereafter be granted on the
same in the United States, the said interest to be held and enjoyed by said Assignee as fully
and exclusively as it would have been held and enjoyed by said Assignor had this Assignment
and transfer not been made, to the full end and term of any Letters Patent which may be
granted thereon, or of any division, renewal, continuation in whole or in part, substitution,
conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said
Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said
application and/or applications, execute, verify, acknowledge and deliver all such further
papers, including applications for Letters Patent and for the reissue thereof, and instruments
of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may
request, to obtain or maintain Letters Patent for said invention and improvement, and to vest
title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the
date(s) indicated.

Tzu-Hung LIN
Tzu-Hung LIN

3/14 2012
Date

Wen-Sung HSU
Wen-Sung HSU

3/14/12
Date

Tai-Yu CHEN
Tai-Yu CHEN

3/14/12
Date